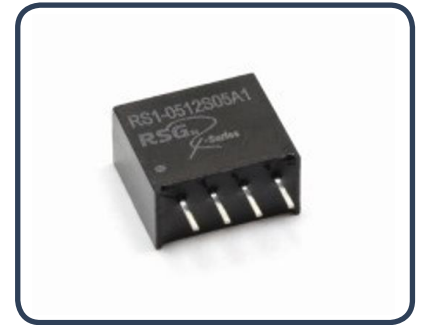


- SIL4 Package
- Input Range $\pm 10\%$
- Efficiency up to 83 %
- Isolation 3000 VDC
- Continuous Short Circuit Protection
- Operation Temperature Range $-40 \sim 95\text{ }^{\circ}\text{C}$ max.
- Non Conductive Black Plastic Case

RoHS



Picture similar

Number Structure

RS1	-	05	05	S	10	A	1
Series / Package		Input Voltage	Output Voltage	Output Type	Power	Int. Code	Isolation Voltage
RS1 = SIL4		03 = 3.3 Vdc 05 = 5.0 Vdc 12 = 12 Vdc 24 = 24 Vdc	03 = 3.3 Vdc 05 = 5.0 Vdc 12 = 12 Vdc 15 = 15 Vdc	S = Single Output	10 = 1 W	Logistics Code	3 = 3000 Vdc

v2 = 2nd Version

Model Selection Guide							
Model Number	Input Voltage Range (VDC)	Input Current		Output Voltage (VDC)	Output Current Full Load (mA)	Efficiency @ FL (% , typ.)	Capacitive Load @ FL (µF, max.)
		No-Load (mA, max.)	Full Load (mA, typ.)				
RS1-0303S10A3v2	2.97-3.63	60	388.5	3.3	303	78	3300
RS1-0305S10A3v2	2.97-3.63	65	383.58	5	200	79	2200
RS1-0312S10A3v2	2.97-3.63	75	374.11	12	83.33	81	470
RS1-0315S10A3v2	2.97-3.63	75	374.11	15	66.67	81	470
RS1-0503S10A3v2	4.5-5.5	45	259.74	3.3	303	77	3300
RS1-0505S10A3v2	4.5-5.5	45	253.16	5	200	79	2200
RS1-0512S10A3v2	4.5-5.5	55	243.9	12	83.33	82	470
RS1-0515S10A3v2	4.5-5.5	60	246.91	15	66.67	81	470
RS1-1203S10A3v2	10.8-13.2	25	106.83	3.3	303	78	3300
RS1-1205S10A3v2	10.8-13.2	25	101.62	5	200	82	2200
RS1-1212S10A3v2	10.8-13.2	25	100.4	12	83.33	83	470
RS1-1215S10A3v2	10.8-13.2	30	102.88	15	66.67	81	470
RS1-2403S10A3v2	21.6-26.4	15	54.11	3.3	303	77	3300
RS1-2405S10A3v2	21.6-26.4	15	52.74	5	200	79	2200
RS1-2412S10A3v2	21.6-26.4	15	50.81	12	83.33	82	470
RS1-2415S10A3v2	21.6-26.4	15	50.2	15	66.67	83	470

ALL SPECIFICATIONS ARE TYPICAL AT 25 °C, NOMINAL INPUT AND FULL LOAD UNLESS OTHERWISE NOTED.

Input Specifications					
Parameter	Conditions	Min.	Typ.	Max.	Unit
Input Voltage Range	3.3 Vdc Input	2.97	3.3	3.63	VDC
	5.0 Vdc Input	4.5	5.0	5.5	
	12 Vdc Input	10.8	12	13.2	
	24 Vdc Input	21.6	24	26.4	
Input Current (No Load)		See Table			mA
Input Current (Full Load)		See Table			mA
Input Filter		Capacitor			-
Input Reflected Ripple Current ⁽¹⁾			20		mApk-pk
Start up Time	Nominal Vin and constant resistive load			10	ms
Recommended input fuse (slow blow)	3.3 Vdc Input		1.0		A
	5.0 Vdc Input		0.5		
	12 Vdc Input		0.25		
	24 Vdc Input		0.1		
Note : 1. Measured with a simulated source inductance of 12 μ H and a source capacitor Cin (47 μ F, ESR < 1 Ω at 100 kHz).					

Output Specifications					
Parameter	Conditions	Min.	Typ.	Max.	Unit
Output Voltage Accuracy		-3.0		+3.0	%
Line Regulation	For 1 % Vin Change	-1.2		+1.2	%
Load Regulation	From 10 % to 100 % Load	3.3V, 5.0V Output		+15	%
		All other Output	-10	+10	
Ripple & Noise ⁽¹⁾	20 MHz Bandwidth		150	200	mVpk-pk
Short Circuit Protection		Continuous and automatic recovery			
Temperature Coefficient		-0.02		+0.02	%/°C
Maximum Capacitive Load	Nominal Vin and constant resistive load	See Table			
Note : 1. Measured with a 0.1 μ F ceramic capacitor.					

Absolute Maximum Ratings					
Parameter	Conditions	Min.	Typ.	Max.	Unit
Input Surge Voltage (100 ms)	3.3 Vdc Input			6	VDC
	5.0 Vdc Input			9	
	12 Vdc Input			18	
	24 Vdc Input			30	
Soldering Temperature	1.5 mm from case 10 sec. max.			260	°C
Note : These are stress ratings. Exposure of devices to any of these conditions may adversely affect long-term reliability.					

General Specifications						
Parameter	Conditions		Min.	Typ.	Max.	Unit
Efficiency			See Table			%
Isolation Voltage	Input-output, and rated for 60 sec.	Suffix "3"	3000			VDC
Isolation Resistance	Input-output		1000			MΩ
Isolation Capacitance	Input-output				65	pF
Switching Frequency				100		kHz
Reliability Calculated MTBF	MIL-HDBK-217 F @ 25 °C			2100		k hours
Safety Standard	IEC / EN / UL 62368-1		Designed to meet			
Environmental compliance	RoHS		Designed to meet			

Environmental Specifications						
Parameter	Conditions		Min.	Typ.	Max.	Unit
Operating Ambient Temperature	See the Derating Curve		-40		95	°C
Maximum Case Temperature					115	°C
Thermal Impedance			50			°C/W
Storage Humidity					95	% rel. H
Storage Temperature			-55		125	°C
Cooling	Natural Convection		30 - 65 LFM			

EMC Specifications			
Parameter	Standard	Condition	Criterion
Conducted Emissions	EN55032	with external components	B
Radiated Emissions	EN55032		B
ESD	IEC 61000-4-2	Air: ±15 kV, Contact: ±8 kV	A
RS	IEC 61000-4-3	10 V/m	A
EFT	IEC 61000-4-4	±2.0 kV with external components	A
Surge	IEC 61000-4-5	±2.0 kV with external components	A
CS	IEC 61000-4-6	10 Vrms	A
PFMF	IEC 61000-4-8	100 A/m	A

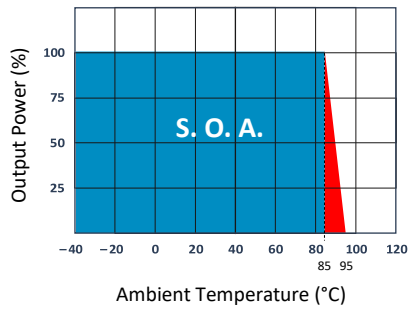
Physical Specifications	
Parameter	Value
Case Material	Nonconductive Black Plastic (UL94V-0 rated)
Pin Material	Copper
Potting Material	Silicone UL94V 0 rated
Weight	1.5 g, typ.
Dimensions	0.46" x 0.24" x 0.40"

Electrical Characteristic Curves

Thermal Derating

To enhance the system reliability, the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum operating temperature, reliability of the unit may be affected.

Temperature Derating Curve

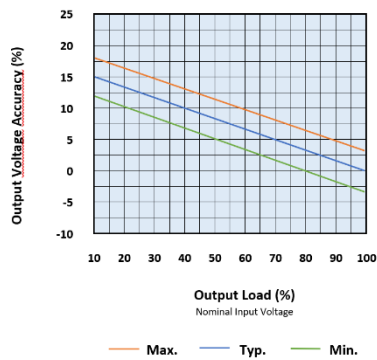


All Models

Output Voltage Tolerance Envelope Curve

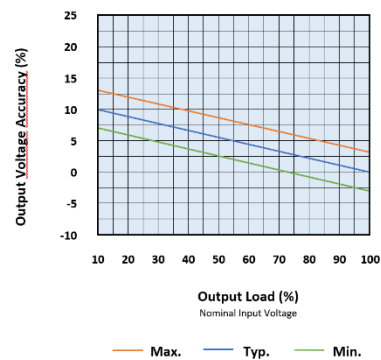
Output Voltage Tolerance Envelope Curve

Output Voltage Tolerance



3.3V & 5V Output

Output Voltage Tolerance

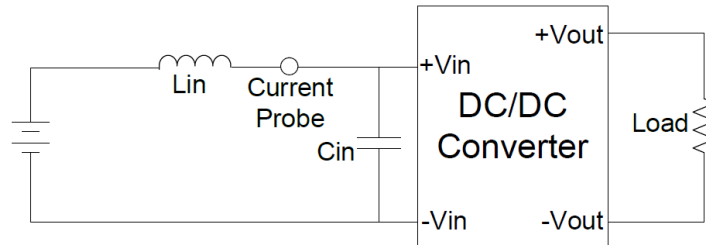


12V & 15V Output

Test Configurations

Input Reflected Ripple Current Test Step

Input reflected ripple current is measured with a source inductor L_{in} (12 μH) and a source capacitor C_{in} (47 μF , ESR < 1.0 Ω at 100 kHz) at nominal input and full load.



Design & Feature Configurations

Isolation Voltage

This series is designed to meet the functional insulation of UL, both input and output should be maintained within SELV limits (less than 42.4 V peak, or 60 Vdc).

The isolation test voltage represents a measure of immunity to transient voltages and the part should never be used as an element of a safety isolation system. The part could be expected to function correctly with hundreds of volts offset applied continuously across the isolation barrier; but then the circuitry on both sides of the barrier must be regarded as operating at an unsafe voltage and further isolation/insulation systems must form a barrier between these circuits and any user-accessible circuitry according to safety standard requirements.

Repeated High-Voltage Isolation Testing

Repeated high-voltage isolation testing of a barrier component can actually degrade isolation capability, to a lesser or greater degree depending on materials, construction and environment. This series has isolation transformers without additional insulation between primary and secondary windings of enameled wire.

While parts can be expected to withstand several times the stated test voltage, the isolation capability does depend on the wire insulation.

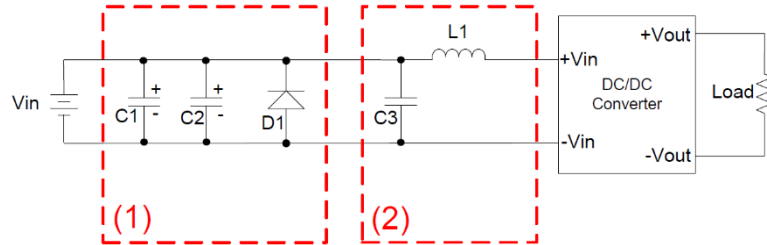
Any material including the enamel (typically polyurethane) is susceptible to eventual chemical degradation when subject to very high applied voltage, thus implying that the number of tests should be strictly limited.

We strongly advise against repeated high voltage isolation testing, but if it is absolutely required, the isolation test voltage should be reduced by 20 % from specified test voltage.

EMC Filter Details

EMC Filter

The part (1) Circuit is used to meet Surge & EFT test, and the part (2) Circuit is used to meet EMI test.

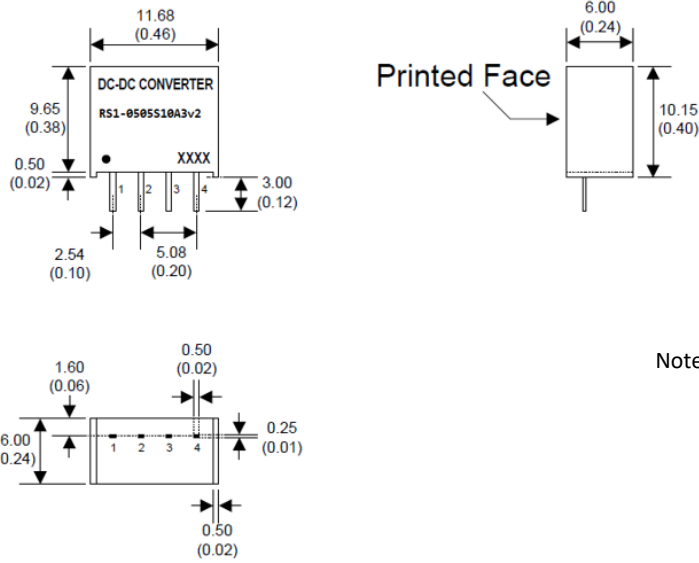


V in	C1	C2	D1	C3	L1
05 Vdc	Nippon Chemi-con KY-Series 470 μ F / 100V	DNP	SMDJ6.0A	MLCC 10 μ F / 50V	10 μ H
12 Vdc			SMDJ9.0A		
15 Vdc			SMDJ18.0A		
24 Vdc		SMDJ30.0A	Nippon Chemi-con KY-Series 680 μ F / 100V		

Pin Connections

SIL 4 Package	
PIN NUMBER	SINGLE
1	-Vin
2	+Vin
3	-Vout
4	+Vout

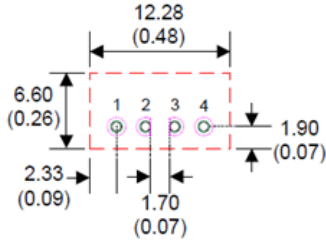
Mechanical Specifications



Notes : All dimensions are typical in millimeters (inches).

1. Pin dimension tolerance: ± 0.05 (± 0.002)
2. Pin pitch and length tolerance: ± 0.35 (± 0.014)
3. Pin to case tolerance: ± 0.5 (± 0.02)
4. Case Tolerance: ± 0.5 (± 0.02)

Recommended Footprint Details



Notes : All dimensions are typical in millimeters (inches).

Pad size(lead free recommended)

1. Through hole (black): $\varnothing 0.80$ (0.031)
2. Top view pad (green): $\varnothing 1.00$ (0.039)
3. Bottom view pad (pink): $\varnothing 1.60$ (0.063)
4. The extra protection of the pads between input (PIN 2) and output (PIN 3) should be needed in order to ensure that the isolation function won't be affected after the module mounts on the PCB.

Notes

The information and specification contained in this data sheet are believed to be correct at time of publication. However, Acal BFi accepts no responsibility for consequences arising from printing errors or inaccuracies. Specifications are subject to change without notice.